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Whether for design-ins, testing or finding your way around – in daily development chores a ready accessible selection of samples is essential. We've composed a number of handy sample kits for you with the most common ratings.

Why not try them out?



Sample kit	Туре	Inductance ratings	Ordering code	
SMT inductors				
Chip Inductors	SIMID 0603-C	nH 1.5 / 1.8 / 2.2 / 2.7 / 3.3 / 3.9 / 4.7 / 5.6 / 6.8 / 8.2 / 10 / 12 / 15 / 18 / 22 / 27 / 33 / 39 / 47 / 56 / 68 / 82 / 100 / 220	B82496X001	
cnip industry.	SIMID 0805-F	nH 2.7/5.6/6.8/8.2/10/12/15/18/ 22/27/33/39/47/56/68/82/ 100/120/150/220/330/470/ 680/820	B82498X001	
Chip inductors	SIMID 1210-T	μH 0.015 / 0.022 / 0.033 / 0.047 / 0.068 / 0.10 / 0.15 / 0.22 / 0.33 / 0.47 / 0.68 / 1.0 / 1.5 / 2.2 / 3.3 / 4.7 / 6.8 / 10 / 15 / 22 / 33 / 47 / 68 / 100	B82422X001	



Sample kit	Туре	Inductance ratings	Ordering code
Chip Inductors.	SIMID 1210-100	μH 0.015 / 0.022 / 0.033 / 0.047 / 0.068 / 0.10 / 0.15 / 0.22 / 0.33 / 0.47 / 0.68 / 1.0 / 1.5 / 2.2 / 3.3 / 4.7 / 6.8 / 10 / 15 / 22 / 33 / 47 / 68 / 100	B82422X100
SMT Inductors SMT-Inductors SMT-Inductors	SIMID 1210-H	μH 0.10/0.15/0.22/0.33/0.47/0.68/ 1/1.5/2.2/3.3/4.7/6.8/10/15/ 22/33/47/68/100/150/220/ 330/470/680	B82422X002
Chip Inductors	SIMID 1812-T	μH 1/1.5/1.8/2.2/3.3/3.9/4.7/6.8/ 8.2/10/15/18/22/33/39/47/ 68/100/150/220/330/470/ 680/1000	B82432X001
Chip Inductors	SIMID 1812-C	μH 1/1.5/1.8/2.2/3.3/3.9/4.7/6.8/ 8.2/10 15/18/22/33/39/47/ 68/100/150/220/330/470/ 680/1000	B82432X002
Chip Inductors:	SIMID 2220-A SIMID 2220-H	μH 1 / 4.7 / 10 / 47 / 100 / 470 / 1000 / 4700 / 10 000 High-current values: 330 / 1000	B82442X001
SMT power indu	ictors		
Power-Induktivitäten Power-Inductors	B82462A4 B82462G4	μH 1/1.5/2.2/3.3/4.7/6.8/10/15/ 22/33/47/68/100/150/220/ 330	B82462X004
Power-Inductors	B82464A4 B82464G4	μH 1/1.5/2.2/3.3/4.7/6.8/10/15/ 22/33/47/68/100/220/470/ 1000	B82464X004
SMT-Power-Induktivitäten SMT Power Inductors	B82471A1/473A1/475A1; B82472G4/G6; B82476A1; B82477G2/G4; B82479A1/G1	μH 10 / 22 / 47 / 100 / 220	B8247XX001



Sample kit	Туре	Inductance ratings	Ordering code			
EPCOS	B82559*A013	μH 0.5 / 0.95 / 1.1 / 1.4 / 2.2 / 2.4 / 3.0 / 3.9	B82559X001			
High-Power Inductors High-Power Inductors	B82559*A025	0.44 / 1.25 / 2.3 / 2.9 / 4.35 / 6.1 / 7.9 / 10	B82559X002			
Chokes for data and signal lines						
EPCOS	B82789C0*/S0* CAN bus double choke	μH 11 / 22 / 51 / 100	B82789X001			
SMD-Datenleitungsdrosseln SMD Data Line Chokes						
EPCOS	B82799 CAN bus double choke	μH 11 / 22 / 33 / 51 / 100 / 220 / 330 / 470	B82799X001			
SMD-Datenleitungsdrosseln SMD Data Line Chokes						
SMD: Datenleitungsdrosseln	B82793C0*/S0* Double choke (open design)	μH 11 / 25 / 51 / 470 / 1000 / 2200 / 4700	B82793X001			
SMD Data Line Chokes						
SMD-Datenleitungsdrossein SMD-Datenleitungsdrossein	B82790C0*/S0* Double choke (closed design)	μH 11 / 25 / 51 / 470 / 1000 / 2200 / 4700	B82790X001			
Chokes for pow	l er lines					
Drosseln für Negzanyvendungen Chokes for Power Lines	B82731M D core choke	mH 3.3 / 6.8 / 10 / 15 / 27 / 39 / 47	B82731X001			
Drosseln für Netzamwendungen Chokes for Power Lines	B82731T E core choke	mH 3.3 / 6.8 / 10 / 15 / 27 / 39 / 47 / 68 / 100	B82731X002			
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Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
 - Particular attention should be paid to the derating curves given there.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
- The following points must be observed if the components are potted in customer applications:
 - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
 - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.



Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application.
 - As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
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